

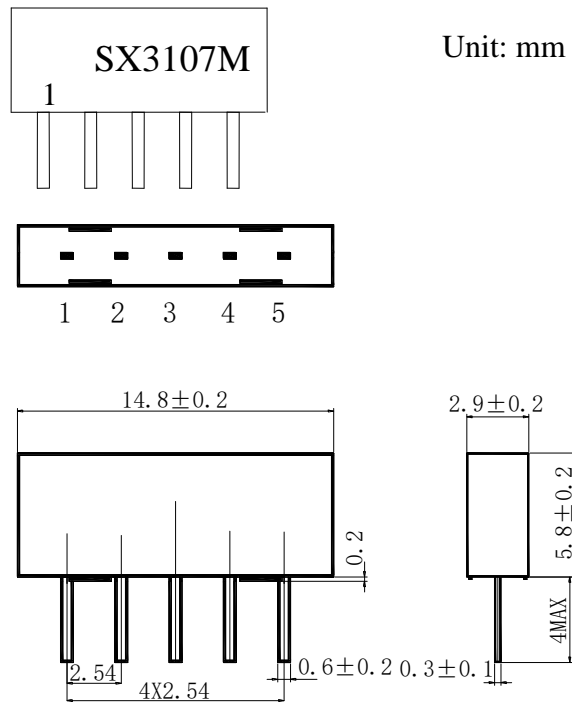


Range:

This specification shall cover the characteristics of SAW filter Strong’s P/N: **SX3107D**

1. Package Dimension

(SIP5D)



Pin No.	Functions
1.	Input
2.	Input-Ground
3.	Chip carrier-Ground
4.	Output
5.	Output

2. Marking

S . Trademark

X3107D . Model

1 . Pin 1

3. Performance

3.1 Use: IF Filter for digital TV

3.2 MAXIMUM RATINGS

DC voltage	V_{DC}	12	V	Between any terminals
AC voltage	V_{PP}	10	V	Between any terminals
Operating Temperature Range	T_A	-25~65	°C	
Storage Temperature Range	T_{stg}	-40~85	°C	

3.3 Electronic Characteristics

Reference temperature: $T_a=25 (50) / ^\circ\text{C}$

Terminating source impedance $Z_S=50 \Omega$

Terminating load impedance $Z_L=2k \Omega // 3 \text{ pF}$

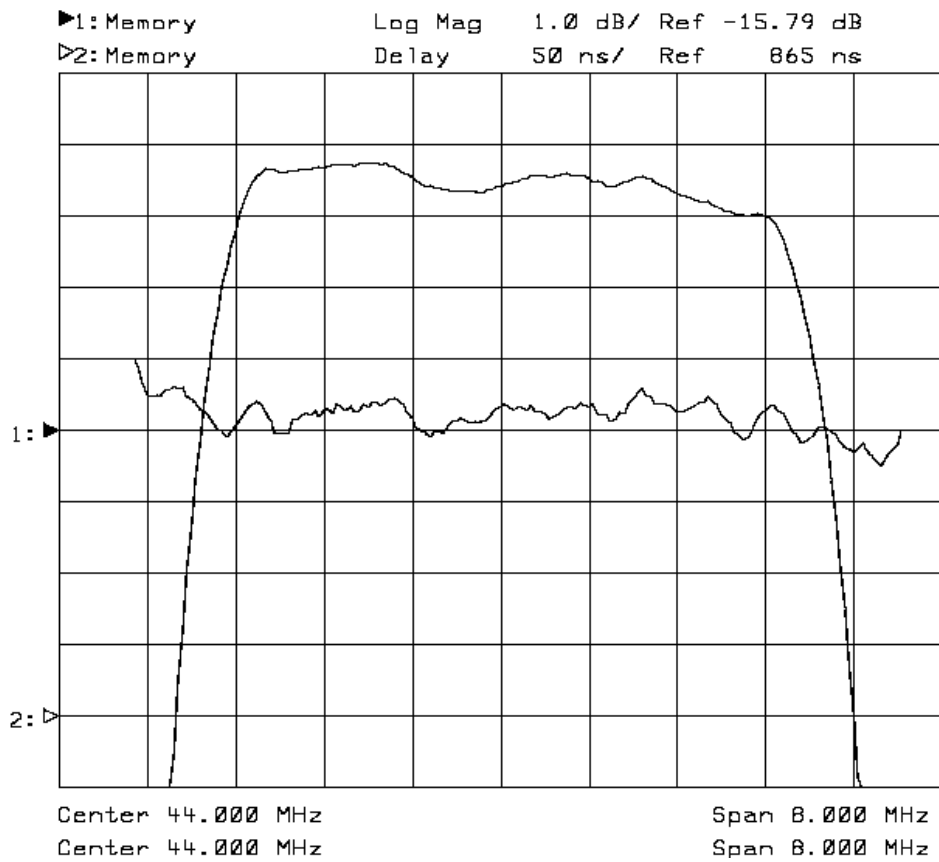
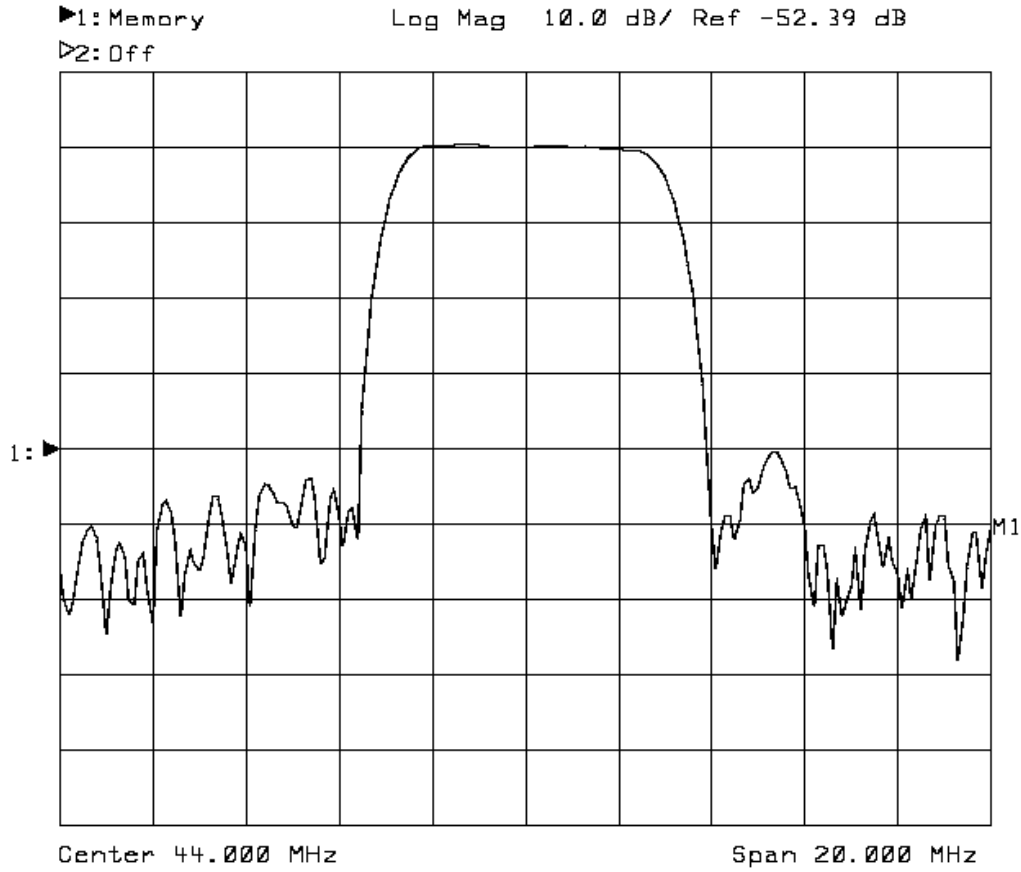
3.4.1. Amplitude Characteristics

Attenuation:

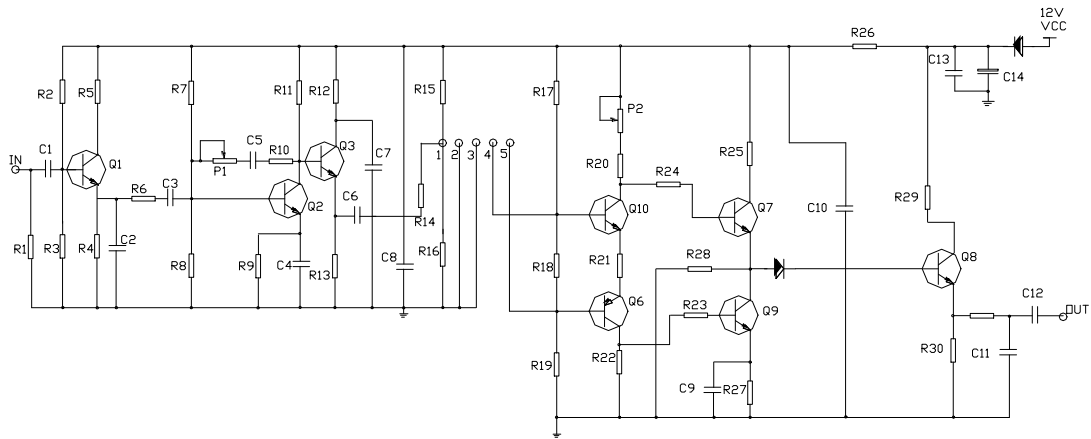
	MIN.	TYP.	MAX.	
Center frequency f_c				
Center frequency between 10dB point	-	44.0	-	MHz
Insertion attenuation				
Reference level for the Following data 44.08(44.00) MHz	12.5	14.0	15.5	dB
Amplitude ripple				
41.75-46.41 (41.67-46.33) MHz	0.0	0.6	1.0	dB
3dB Pass Bandwidth	5.4	5.6	5.8	MHz
30dB Pass Bandwidth	7.0	7.3	7.6	MHz
Lower side lobe				
35.08-38.08(35.00-38.00) MHz	41.0	48.0	-	dB
38.08-40.13(38.00-40.05) MHz	37.0	45.0	-	dB
Upper side lobe				
48.03-50.33(47.95-50.25) MHz	36.0	45.0	-	dB
50.33-55.08(50.25-55.00) MHz	40.0	50.0	-	dB
Reflected Wave Signal Suppression	42.0	52.0		dB
Feed through Signal Suppression	50.0	56.0		dB
Group delay ripple				
41.75...46.41(41.67...46.33) MHz	-	40	-	ns
Impedance at 44.08 MHz				
Input Impedance	-	1.5 15.4	-	K Ω pF
Output Impedance		1.3 4.6		K Ω pF
Temperature Coefficient of frequency	-	-72.0	-	ppm/K

3.5 Frequency Characteristics

3.5.1 Frequency response



4. Test Circuit



Test Circuit

5. RELIABILITY TEST

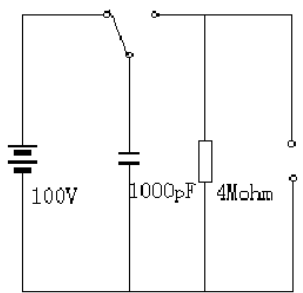
5.1 Environmental Performance Characteristics

Item Test condition	Allowable change of absolute Level at center frequency(dB)
High temperature test 70°C 1000H	< 1.0
Low temperature test -40°C 1000H	< 1.0
Humidity test 40°C 90-95% 1000H	< 1.0
Thermal shock -20°C==25°C==80°C 20 cycle 30M 10M 30M	< 1.0
Solder temperature test Sold temp.260°C for 10 sec.	< 1.0
Soldering Immerse the pins melt solder at 260°C+5/-0°C for 5 sec.	More then 95% of total area of the pins should be covered with solder

5.2 Mechanical Test

Item Test condition	Allowable change of absolute Level at center frequency(dB)
Vibration test 600-3300rpm amplitude 1.5mm 3 directions 2 H each	<1.0
Drop test On maple plate from 1 m high 3 times	<1.0
Lead pull test Pull with 1 kg force for 30 seconds	<1.0
Lead bend test 90° bending with 500g weigh 2 times	<1.0

5.3 Voltage Discharge Test

Item Test condition	Allowable change of absolute Level at center frequency(dB)
Surge test Between any two electrode 	<1.0

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